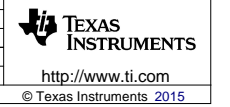


Orderable: N/A	Designed for: PA - Linear	Mod. Date: 2/4/2016
TID #: N/A	Project Title: T1PD209	
Number: T1DUBA5	Rev: E2	Sheet Title: Thermocouple with Cold Junction Comp. RTD
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 2
Drawn By:	File: T1PD209SCH_E2.SchDoc	Size: B
Engineer: Tim Claycomb	Contact: http://www.ti.com/support	

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H5
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H6
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H7
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H8
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H1
1902C

H2
1902C

H3
1902C

H4
1902C

PCB
LOGO
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PCB
LOGO
Pb-Free Symbol

ZZ1
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: N/A	Project Title: TIPD209		
Number: TIDUBA5	Rev: E2	Sheet Title: Thermocouple with Cold Junction Comp. RTD	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 2	
Drawn By:	File: TIPD209_Hardware_E2.SchDoc	Size: B	
Engineer: Tim Claycomb	Contact: http://www.ti.com/support		

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